

# MOS FIELD EFFECT TRANSISTOR $\mu$ PA1802

## N-CHANNEL MOS FIELD EFFECT TRANSISTOR **FOR SWITCHING**

### **DESCRIPTION**

The  $\mu$ PA1802 is a switching device which can be driven directly by a 2.5-V power source.

The  $\mu$ PA1802 features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

### **FEATURES**

- Can be driven by a 2.5-V power source
- · Low on-state resistance

 $R_{DS(on)1} = 23 \text{ m}\Omega \text{ MAX.} \text{ (Vgs} = 4.5 \text{ V, Ip} = 3.5 \text{ A)}$ 

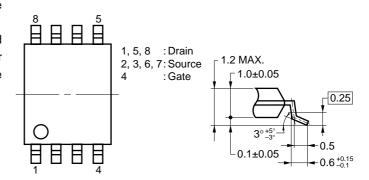
 $R_{DS(on)2} = 25 \text{ m}\Omega$  MAX. (Vgs = 4.0 V, ID = 3.5 A)

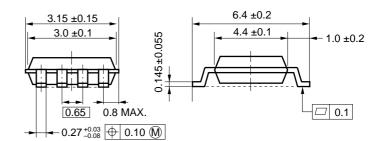
 $R_{DS(on)3} = 32 \text{ m}\Omega \text{ MAX.} \text{ (Vgs} = 2.5 \text{ V, ID} = 3.5 \text{ A)}$ 

### ORDERING INFORMATION

PART NUMBER	PACKAGE
μPA1802GR-9JG	Power TSSOP8

### PACKAGE DRAWING (Unit: mm)

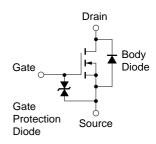




### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25$ °C)

Drain to Source Voltage	VDSS	20	V
Gate to Source Voltage	Vgss	±12	V
Drain Current (DC)	ID(DC)	±7.0	Α
Drain Current (pulse) Note1	ID(pulse)	±28	Α
Total Power Dissipation Note2	Рт	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	$T_{stg}$	-55 to +150	°C

### **EQUIVALENT CIRCUIT**



- **Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%
  - 2. Mounted on ceramic substrate of 5000 mm<sup>2</sup> x 1.1 mm

# Remark

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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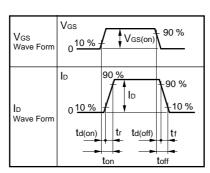


### **ELECTRICAL CHARACTERISTICS (TA = 25°C)**

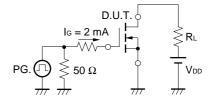
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V			10	μΑ
Gate Leakage Current	Igss	Vgs = ±12 V, Vps = 0 V			±10	μΑ
Gate Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	0.5	0.8	1.5	V
Forward Transfer Admittance	y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 3.5 A	5	16		S
Drain to Source On-state Resistance	RDS(on)1	Vgs = 4.5 V, ID = 3.5 A		16	23	mΩ
	RDS(on)2	Vgs = 4.0V, ID = 3.5 A		17	25	mΩ
	RDS(on)3	Vgs = 2.5 V, ID = 3.5 A		21	32	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = 10 V		970		pF
Output Capacitance	Coss	V <sub>G</sub> S = 0 V		510		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		230		pF
Turn-on Delay Time	td(on)	V <sub>DD</sub> = 10 V		60		ns
Rise Time	tr	ID = 3.5 A		210		ns
Turn-off Delay Time	t <sub>d(off)</sub>	V <sub>GS(on)</sub> = 4.0 V		590		ns
Fall Time	t <sub>f</sub>	$R_G = 10 \Omega$		820		ns
Total Gate Charge	Q <sub>G</sub>	V <sub>DS</sub> = 16 V		13		nC
Gate to Source Charge	Qgs	ID = 7.0 A		3		nC
Gate to Drain Charge	Q <sub>GD</sub>	V <sub>G</sub> S = 4.0 V		5		nC
Diode Forward Voltage	V <sub>F</sub> (S-D)	IF = 7.0 A, VGS = 0 V		0.74		V

### **TEST CIRCUIT 1 SWITCHING TIME**

# PG. $\uparrow$ $R_{R_{G}}$ $\downarrow$ $V_{GS}$ 0 $\tau = 1 \mu s$ Duty Cycle $\leq 1 \%$

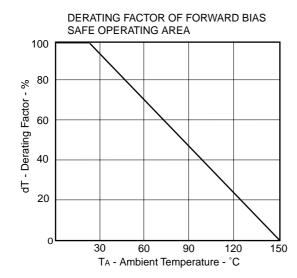


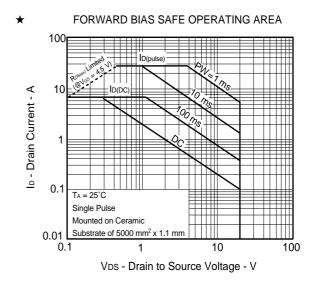
### **TEST CIRCUIT 2 GATE CHARGE**

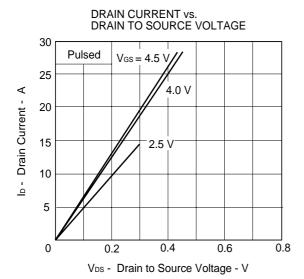


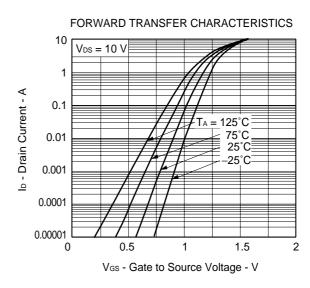


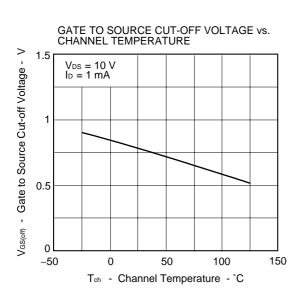
### TYPICAL CHARACTERISTICS (TA = 25 °C)

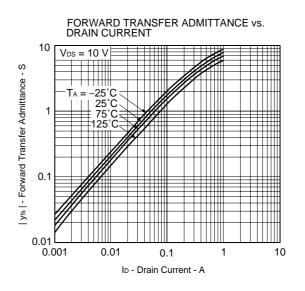




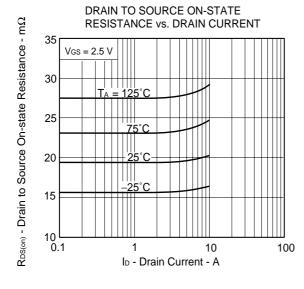


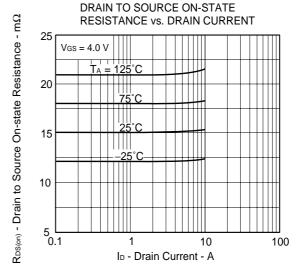


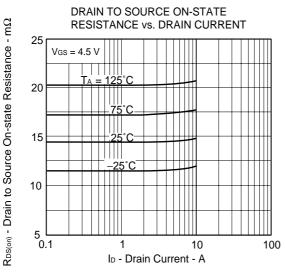


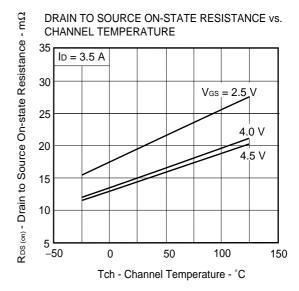


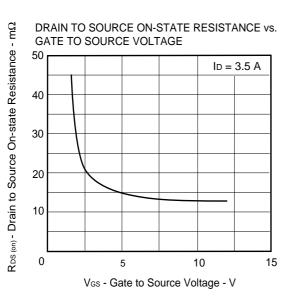
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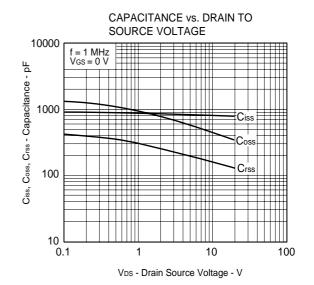


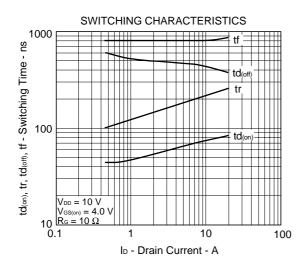


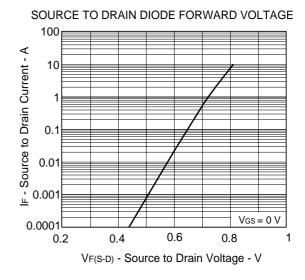


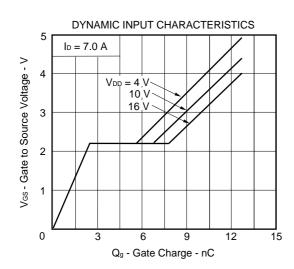


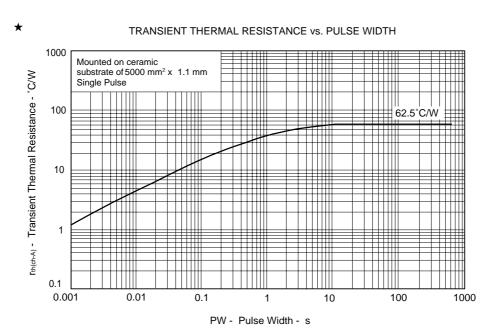












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NEC  $\mu$ PA1802

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